MCL1005

Multilayer chip inductor

Product features

- 0402 (1005 metric) package
- High self resonant frequency (SRF)
- Multilayer monolithic construction yields high reliability
- Suitable for wave and reflow soldering
- Inductance range from 1.0 nH to 360 nH
- Moisture sensitivity level (MSL): 1

Applications

- Industrial connectivity (IoT)
- Wireless communiations
  - Bluetooth
  - WiFi
  - Antenna
- Machine-to-machine (M2M)
- Mobile phones
- Wearable devices
- Wireless LAN
- Computing/gaming consoles
- Broadband components
- RF transciever modules

Environmental data

- Operating temperature range: -55 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020 (latest revision) compliant

Powering Business Worldwide

Product specifications

Part number	OCL (nH) ±5%	I Rated (mA) maximum	DCR (Ω) maximum @ +25°C	SRF (MHz) minimum	Q (minimum)	Test frequency (MHz)	Test voltage (mV)
MCL1005-1R0-R	1.0 ±0.3nH	400	0.10	10000	8	100	50
MCL1005-1R1-R	1.1 ±0.3nH	400	0.10	10000	8	100	50
MCL1005-1R2-R	1.2 ±0.3nH	400	0.10	10000	8	100	50
MCL1005-1R3-R	1.3 ±0.3nH	400	0.10	10000	8	100	50
MCL1005-1R5-R	1.5 ±0.3nH	300	0.10	6000	8	100	50
MCL1005-1R6-R	1.6 ±0.3nH	300	0.12	6000	8	100	50
MCL1005-1R8-R	1.8 ±0.3nH	300	0.12	6000	8	100	50
MCL1005-2R0-R	2.0 ±0.3nH	300	0.15	6000	8	100	50
MCL1005-2R2-R	2.2 ±0.3nH	300	0.15	6000	8	100	50
MCL1005-2R4-R	2.4 ±0.3nH	300	0.15	6000	8	100	50
MCL1005-2R7-R	2.7 ±0.3nH	300	0.15	6000	8	100	50
MCL1005-3R0-R	3.0 ±0.3nH	300	0.20	6000	8	100	50
MCL1005-3R3-R	3.3 ±0.3nH	300	0.20	6000	8	100	50
MCL1005-3R6-R	3.6 ±0.3nH	300	0.20	4000	8	100	50
MCL1005-3R9-R	3.9 ±0.3nH	300	0.20	4000	8	100	50
MCL1005-4R3-R	4.3 ±0.3nH	300	0.20	4000	8	100	50
MCL1005-4R7-R	4.7 ±0.3nH	300	0.25	4000	8	100	50
MCL1005-5R1-R	5.1 ±0.3nH	300	0.25	4000	8	100	50
MCL1005-5R6-R	5.6 ±0.3nH	300	0.25	4000	8	100	50
MCL1005-6R2-R	6.2 ±0.3nH	300	0.30	3900	8	100	50
MCL1005-6R8-R	6.8	300	0.30	3900	8	100	50
MCL1005-7R5-R	7.5	300	0.40	3700	8	100	50
MCL1005-8R2-R	8.2	300	0.40	3600	8	100	50
MCL1005-9R1-R	9.1	300	0.40	3400	8	100	50
MCL1005-100-R	10	300	0.40	3200	8	100	50
MCL1005-120-R	12	300	0.50	2700	8	100	50
MCL1005-150-R	15	300	0.50	2300	8	100	50
MCL1005-180-R	18	300	0.60	2100	8	100	50
MCL1005-200-R	20	300	0.60	2000	8	100	50
MCL1005-220-R	22	300	0.60	1900	8	100	50
MCL1005-270-R	27	300	0.70	1600	8	100	50
MCL1005-330-R	33	200	0.80	1300	8	100	50
MCL1005-390-R	39	200	1.00	1200	8	100	50
MCL1005-430-R	43	200	1.10	1100	8	100	50
MCL1005-470-R	47	200	1.10	1000	8	100	50
MCL1005-560-R	56	200	1.20	750	8	100	50
MCL1005-680-R	68	180	1.40	750	8	100	50
MCL1005-820-R	82	150	2.40	750	8	100	50
MCL1005-101-R	100	150	2.60	700	8	100	50

1. Test frequency and voltage are for OCL and Q at +25 °C
2. Resistance to soldering heat: +260 ±5 °C for 10 ± 1 second
3. At low temperature resistance (-55 ±2°C) the inductance change is within ±10% and the Q within ±20%
4. At high temperature resistance (+125 ±2°C) the inductance change is within ±10% and the Q within ±20%
5. At high temperature load (+125 ±2°C) the inductance change is within ±10% and the Q within ±20%
6. Rated I: When rated I is applied to the product, self-temperature rise will be 40 °C or less.
7. Part Number Definition: MCL1005-xxx-R
   MCL1005 = Product code and size
   xxx= inductance value in nH, R= decimal point,
   If no R is present then last character equals number of zeros
   -R suffix = RoHS compliant

Product specifications

Part number	OCL (nH) ±5%	I Rated (mA) maximum	DCR (Ω) maximum @ +25°C	SRF (MHz) minimum	Q (minimum)	Test frequency (MHz)	Test voltage (mV)
MCL1005-121-R	120	150	2.80	600	8	100	50
MCL1005-151-R	150	100	3.20	550	8	100	50
MCL1005-181-R	180	100	3.70	500	8	100	50
MCL1005-221-R	220	100	4.00	450	8	100	50
MCL1005-271-R	270	100	4.50	400	8	100	50
MCL1005-331-R	330	50	7.00	350	6	50	50
MCL1005-361-R	360	50	7.50	300	6	50	50

1. Test frequency and voltage are for OCL and Q at +25 °C
2. Resistance to soldering heat: +260 ±5 °C for 10 ± 1 second
3. At low temperature resistance (-55 ±2°C) the inductance change is within ±10% and the Q within ±20%
4. At high temperature resistance (+125 ±2°C) the inductance change is within ±10% and the Q within ±20%
5. At high temperature load (+125 ±2°C) the inductance change is within ±10% and the Q within ±20%
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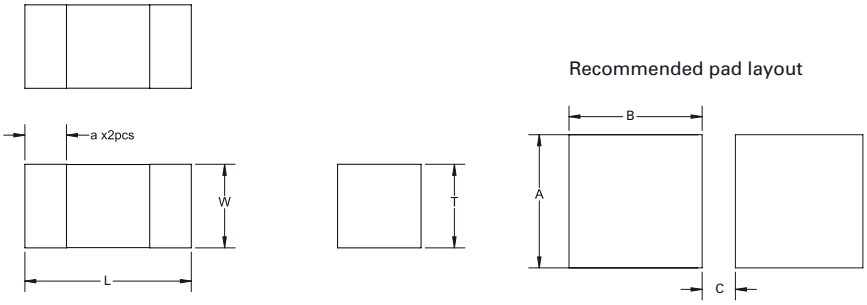
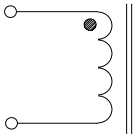
   xxx= inductance value in nH, R= decimal point,
   If no R is present then last character equals number of zeros
   -R suffix = RoHS compliant

Dimensions (mm)



Schematic



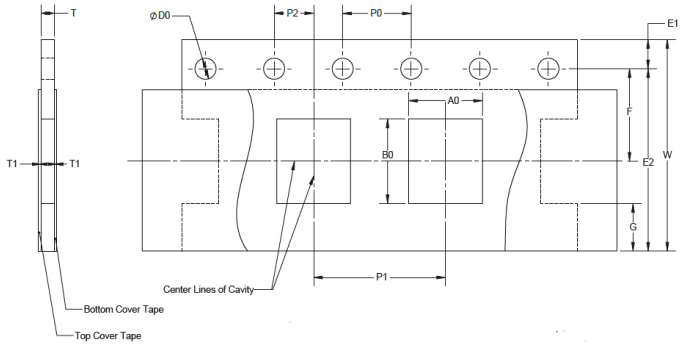
Part Number	L	W	T	a	A	B	C
MCL1005-xxx-R	1.0 ±0.15	0.50 ±0.15	0.50 ±0.15	0.25 ±0.10	0.85 ±0.10	0.8 ±0.10	0.2 ±0.10

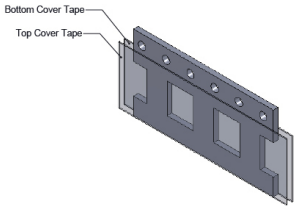
No part marking
All soldering surfaces to be coplanar within 0.1 millimeters
Tolerances are ±0.2 millimeters unless stated otherwise
Pad layout tolerances are ±0.1 millimeters unless stated otherwise
Do not route traces or vias underneath the inductor

Packaging information (mm)

Drawing not to scale

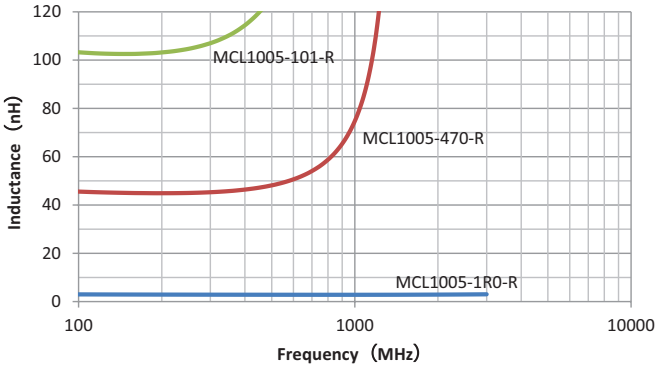
Supplied in tape and reel packaging, 10000 parts per 7″ diameter reel



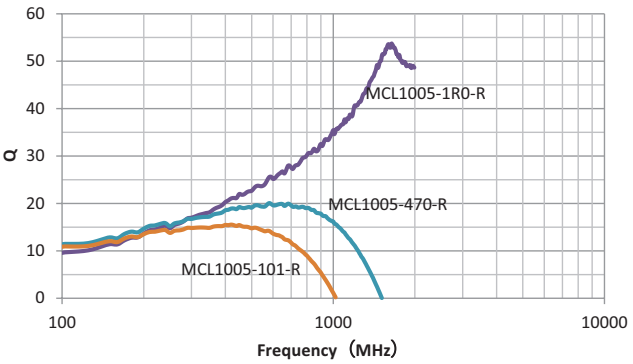


W ±0.3	8.00
F±0.05	3.50
E1±0.10	1.75
E2 Min	6.25
P0±0.10	4.00
P1±0.05	2.00
P2±0.1	2.00
D0+0.10/-0	1.50
A0	0.65±0.10
B0	1.15±0.10
T Max	0.8
T1 Max	na

Inductance vs frequency



Q vs frequency



Solder reflow profile

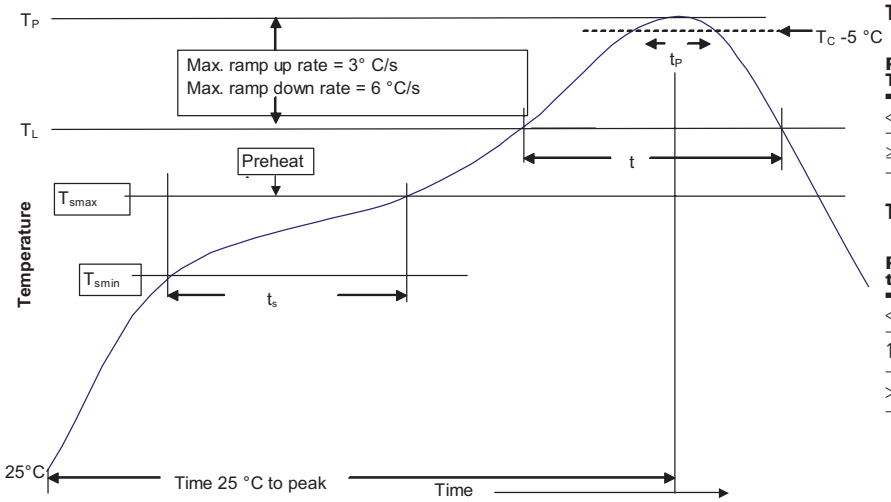


Table 1 - Standard SnPb solder (T_C)

Package Thickness	Volume mm3 <350	Volume mm3 ≥350
<2.5 mm)	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2 - Lead (Pb) free solder (T_C)

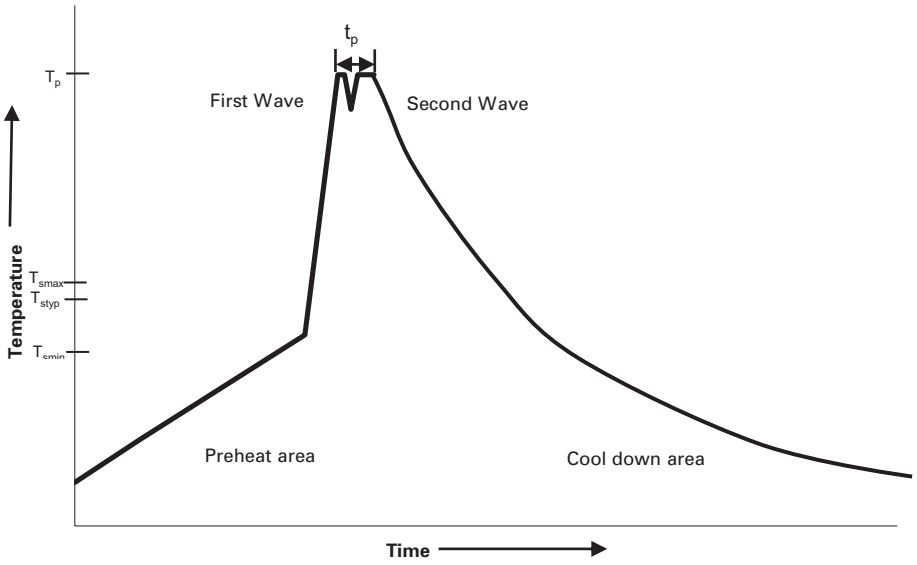
Package thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 – 2.5 mm	260 °C	250 °C	245 °C
>2.5 mm	250 °C	245 °C	245 °C

Reference J-STD-020

Profile feature		Standard SnPb solder	Lead (Pb) free solder
Preheat and soak	• Temperature min. (T_{smin})	100 °C	150 °C
	• Temperature max. (T_{smax})	150 °C	200 °C
	• Time (T_{smin} to T_{smax}) (t_S)	60-120 seconds	60-120 seconds
Average ramp up rate T_{smax} to T_p		3 °C/ second max.	3 °C/ second max.
Liquidous temperature (T_L) Time at liquidous (t_L)		183 °C 60-150 seconds	217 °C 60-150 seconds
Peak package body temperature (T_P)*		Table 1	Table 2
Time (t_p)** within 5 °C of the specified classification temperature (T_C)		10 seconds**	10 seconds**
Average ramp-down rate (T_p to T_{smax})		6 °C/ second max.	6 °C/ second max.
Time 25 °C to peak temperature		6 minutes max.	8 minutes max.

* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.
** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

Wave solder profile



Reference EN 61760-1:2006

Profile feature		Standard SnPb solder	Lead (Pb) free solder
Preheat	• Temperature min. (T_{smin})	100 °C	100 °C
	• Temperature typ. (T_{styp})	120 °C	120 °C
	• Temperature max. (T_{smax})	130 °C	130 °C
	• Time (T_{smin} to T_{smax}) (t_s)	70 seconds	70 seconds
Δ preheat to max Temperature		150 °C max.	150 °C max.
Peak temperature (T_p)*		235 °C – 260 °C	250 °C – 260 °C
Time at peak temperature (t_p)		10 seconds max 5 seconds max each wave	10 seconds max 5 seconds max each wave
Ramp-down rate		~ 2 K/s min ~3.5 K/s typ ~5 K/s max	~ 2 K/s min ~3.5 K/s typ ~5 K/s max
Time 25 °C to 25 °C		4 minutes	4 minutes

Manual solder

+350 °C, 4-5 seconds. (by soldering iron), generally manual, hand soldering is not recommended.

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Eaton
Electronics Division
1000 Eaton Boulevard
Cleveland, OH 44122
United States
www.eaton.com/electronics

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Powering Business Worldwide

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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.

Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)
Факс: 8 (812) 320-02-42
Электронная почта: org@eplast1.ru
Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.